👋 Texas Instruments

Bill of Materials

PMP10580

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Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer	Alternate Part	PCB Footprint	Note
1	1	U2		HEX Schmitt-Trigger Buffer(SN74AUC17RGYR)	Texas Instruments, Inc	Part Number SN74AUC17RGYR			
2	1	U4		8-Channel, 50 kSPS to 200 kSPS, 12-Bit A/D Converter	Texas Instruments, Inc	ADC128S022CIMTX/NOPB			
3	2	REG1, REG3		REG, LDO, 1.5A, FLEXCAP, 8-LLP	Texas Instruments, Inc	LP38500SD-ADJ/NOPB			
4	2	REG2		Ultra Low Noise, 150 mA Linear Regulator	Texas Instruments, Inc	LP5900SD-2.5/NOPB			
5		REGZ		Ollia Low Noise, 150 IIIA Lillear Regulator	Texas instruments, inc	LF39003D-2.3/NOFB			
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